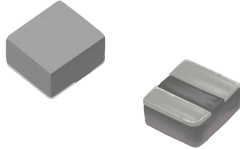


MDTE Series

Wire Wound Molded SMD Power Inductors Size 25201B



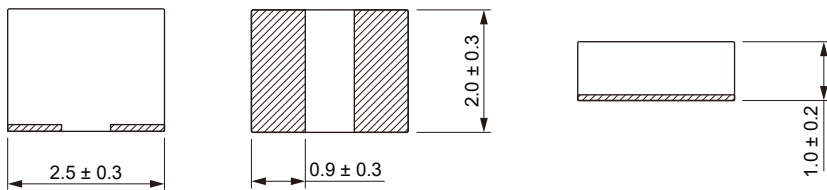
FEATURES

- Soft saturation
- High current, low DCR, high efficiency
- Very low acoustic noise and very low leakage flux noise
- High reliability
- 100% Lead(Pb)-Free and RoHS compliant
- Operating temperature -40~+125 °C (Including self - temperature rise)
- Quantity: 3000pcs

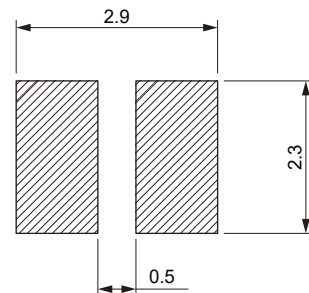
APPLICATION

- Note PC power system, incl. IMVP-6
- DC/DC converter

Dimensions: [mm]



Land Pattern: [mm]

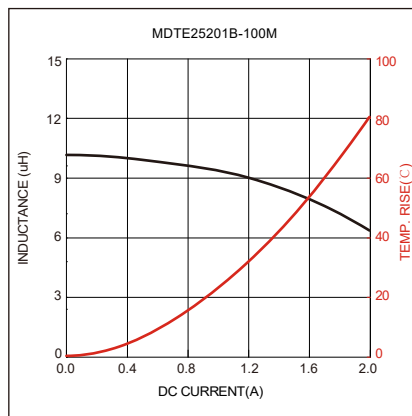
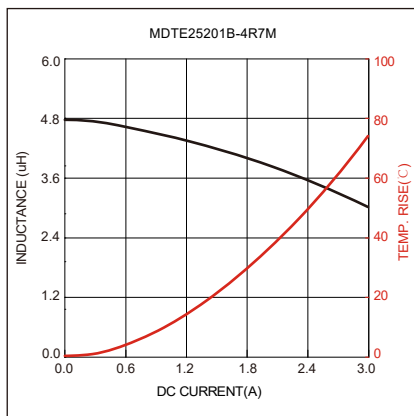
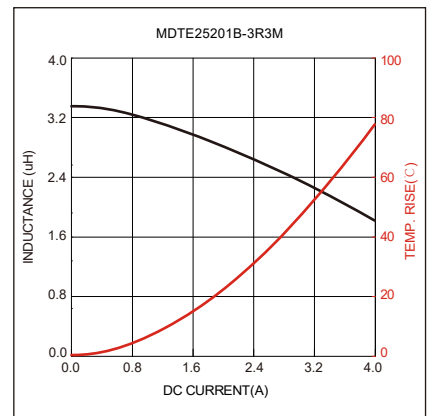
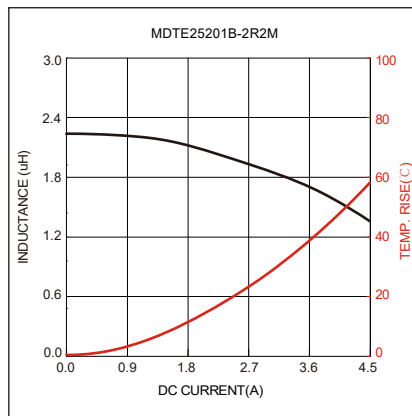
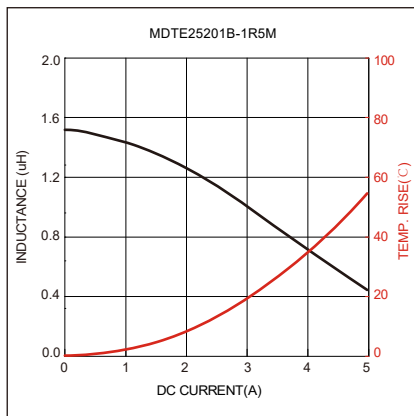
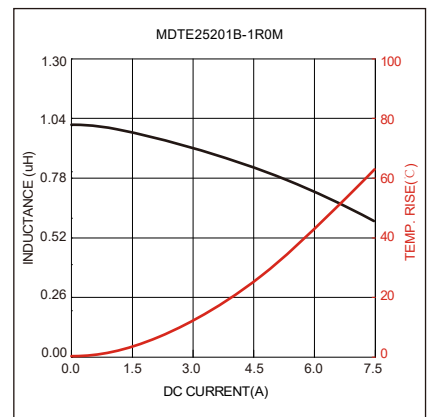
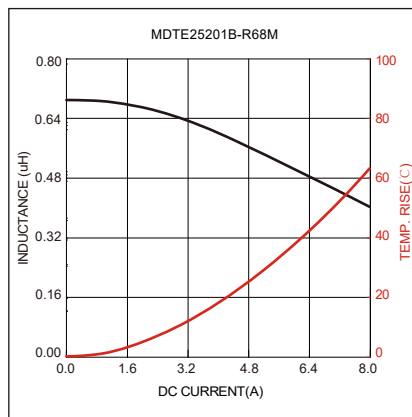
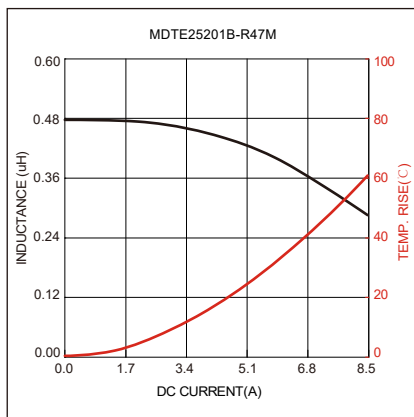
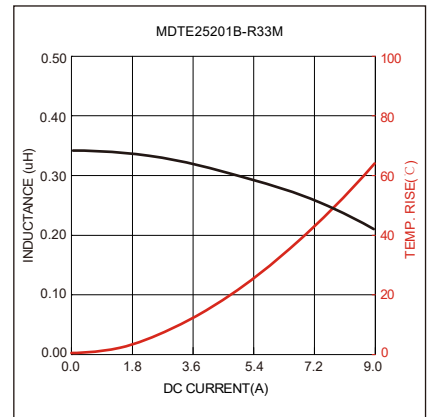
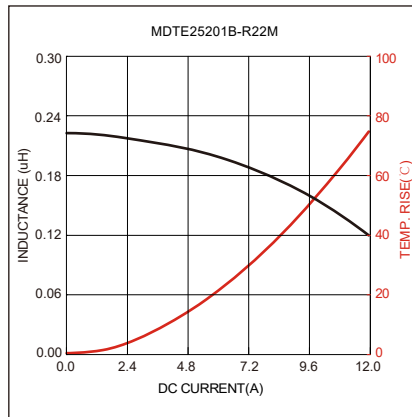
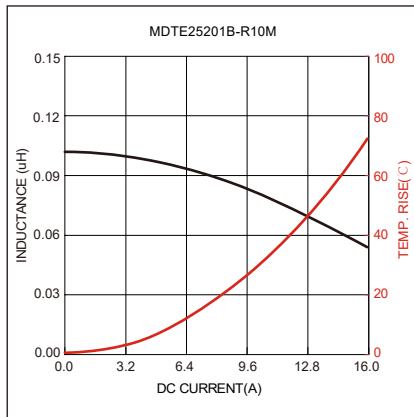


Part No	Inductance @ 1MHz/1V (μH)	Tolerance	Saturation Current Typ. (A)	Saturation Current Max. (A)	Temperature Rise Current Typ. (A)	Temperature Rise Current Max. (A)	DC Resistance Max. (mΩ)
MDTE25201B-R10M	0.10	±20%	12.0	10.0	12.0	8.0	7.0
MDTE25201B-R22M	0.22	±20%	9.6	9.0	8.2	7.6	10.8
MDTE25201B-R33M	0.33	±20%	8.0	7.5	7.0	6.4	12.0
MDTE25201B-R47M	0.47	±20%	7.4	6.8	6.7	6.0	20.0
MDTE25201B-R68M	0.68	±20%	6.5	6.0	6.1	5.5	23.0
MDTE25201B-1R0M	1.00	±20%	5.8	5.3	5.7	5.2	37.0
MDTE25201B-1R5M	1.50	±20%	4.7	4.4	4.6	4.2	32.0
MDTE25201B-2R2M	2.20	±20%	4.0	3.3	3.7	3.3	60.0
MDTE25201B-3R3M	3.30	±20%	3.0	2.7	2.8	2.5	97.0
MDTE25201B-4R7M	4.70	±20%	2.8	2.2	2.3	2.0	204.0
MDTE25201B-100M	10.0	±20%	1.6	1.45	1.2	1.05	400.0

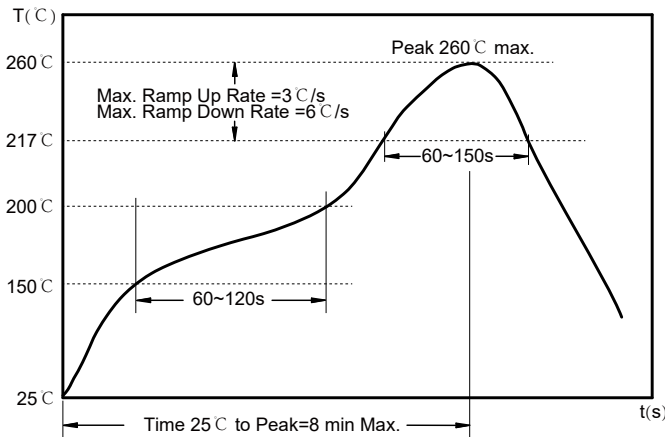
Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is $\Delta T=40^{\circ}\text{C}$

Typical Electrical Characteristics:



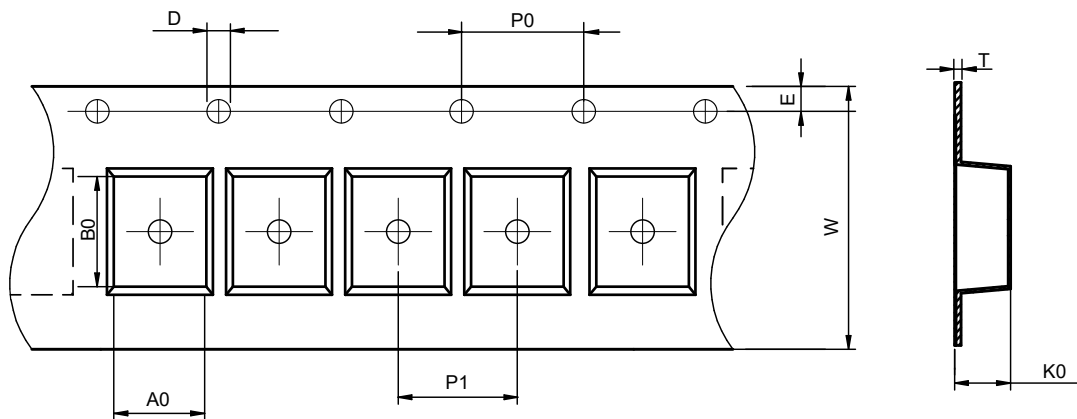
Soldering Reflow:



Preheat condition: 150 ~200°C / 60~120 sec.
 Allowed time above 217°C : 60~150 sec.
 Max temperature: 260°C.
 Allowed Reflow time: 2x max.

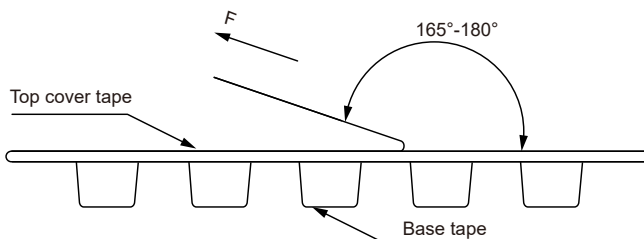
Packaging Information:

Tape Dimension:

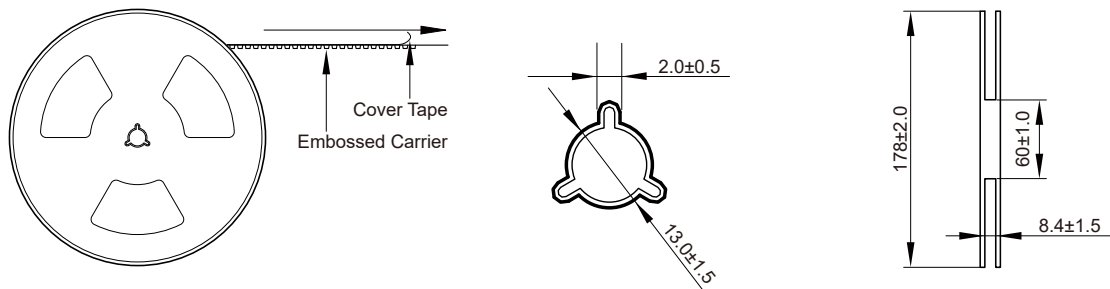
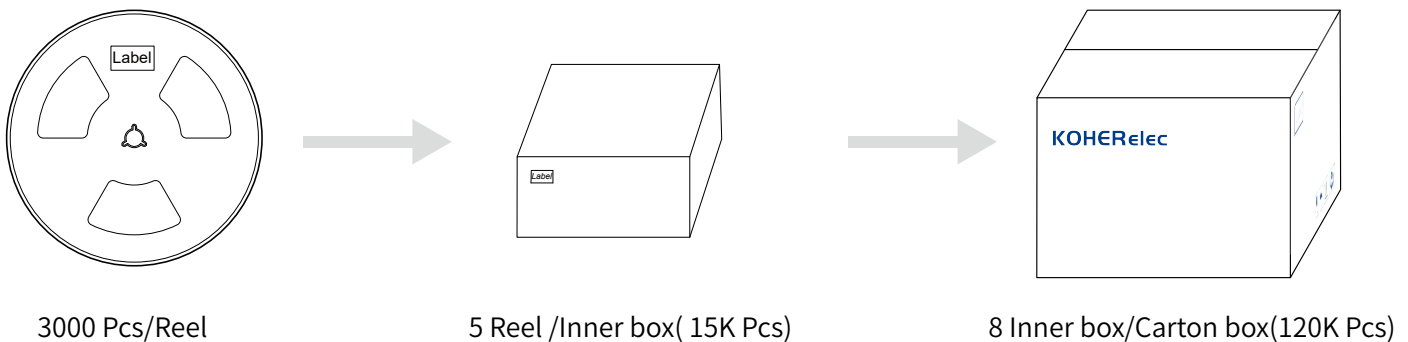


Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE25201B	2.4±0.1	2.9±0.1	1.5±0.1	4.0±0.1	4.0±0.1	8.0±0.1	1.4±0.1	1.75±0.1	0.25±0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 0.98 N

Reel Dimension: [mm]

Packaging Quantity:

Cautions and Warnings:
Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.